

# **Approval Sheet**

Customer	
Product Number	M4UI-2GSV1C0K-F
Module speed	PC4-2666
Pin	288 pin
CI-tRCD-tRP	19-19-19
Operating Temp	0℃~85℃
Date	15 <sup>th</sup> Jan 2019

# The Total Solution For Industrial Flash Storage



### 1. Features

### **Key Parameter**

Industry	Speed	eed Data Rate MT/s		CL	tRCD	tRP	
Nomenclature	Grade	CL=15	CL=17	CL=19	CL	IKCD	IKP
PC4-2666	I	2133	2400	2666	19	19	19

- JEDEC Standard 288-pin Dual In-Line Memory Module
- Intend for PC4-2666 applications
- Inputs and Outputs are SSTL-12 compatible
- VDD=VDDQ= 1.2 Volt (1.14V~1.26V)
- VPP=2.5 Volt (2.375V~2.75V)
- VDDSPD=2.2-3.6V
- Low-Power auto self-refresh (LPASR)
- SDRAMs have 8 internal banks for concurrent operation (2 Bank Group of 4 banks each)
- Normal and Dynamic On-Die Termination for data, strobe and mask signals.
- · Data bus inversion (DBI) for data bus

- Fixed burst chop (BC) of 4 and burst length (BL) of 8 via the MRS
- Selectable BC4 or BL8 on-the fly (OTF)
- Golden Connector
- Fly-By topology
- Terminated control, command and address bus
- Programmable /CAS Latency:
   10,11,12,13,14,15,16,17,18,19,20
- Operation temperature  $(0^{\circ}C \sim 85^{\circ}C)$
- On-die VREFDQ generation and Calibration
- On-Board EEPROM
- RoHS and Halogen free (Section 11)



# 2. Ordering Information

DDR4 UDIMM											
Part Number	Density	Speed	DIMM	Number of	Number	ECC					
r alt Nullibel	Density		Organization	DRAM	of rank	LCC					
M4UI-2GSV1C0K-F	2GB	PC4-2666	256Mx64	4	1	N					



# Pin Configurations (Front side/Back side)

Pin	Front	Pin	Back	Pin	Front	Pin	Back	Pin	Front	Pin	Back	Pin	Front	Pin	Back
1	NC	145	NC	37	VSS	181	DQ29	73	VDD	217	VDD	109	VSS	253	DQ41
2	VSS	146	VREFCA	38	DQ24	182	VSS	74	CK0_t	218	CK1_t	110	DM5_n/ DBI5_n,NC	254	vss
3	DQ4	147	vss	39	vss	183	DQ25	75	CK0_c	219	CK1_c	111	NC	255	DQS5_c
4	VSS	148	DQ5	40	DM3_n/ DBI3_n,NC	184	VSS	76	VDD	220	VDD	112	vss	256	DQS5_t
5	DQ0	149	VSS	41	NC	185	DQS3_c	77	VIT	221	VIT	113	DQ46	257	vss
6	VSS	150	DQ1	42	VSS	186	DQS3_t	78	EVENT_n,NF	222	PARITY	114	VSS	258	DQ47
7	DM0_n/ DBI0_n	151	vss	43	DQ30	187	VSS	79	A0	223	VDD	115	DQ42	259	vss
8	NC	152	DQS0_c	44	VSS	188	DQ31	80	VDD	224	BA1	116	VSS	260	DQ43
9	VSS	153	DQS0_t	45	DQ26	189	VSS	81	BA0	225	A10/AP	117	DQ52	261	vss
10	DQ6	154	VSS	46	VSS	190	DQ27	82	RAS_n /A16	226	VDD	118	VSS	262	DQ53
11	VSS	155	DQ7	47	CB4/NC	191	VSS	83	VDD	227	NC	119	DQ48	263	vss
12	DQ2	156	VSS	48	VSS	192	CB5,NC	84	CS0_n	228	WE_n/ A14	120	VSS	264	DQ49
13	VSS	157	DQ3	49	CB0/NC	193	VSS	85	VDD	229	VDD	121	DM6_n/ DBI6_n	265	VSS
14	DQ12	158	VSS	50	VSS	194	CB1,NC	86	CAS_n/ A15	230	NC	122	NC	266	DQS6_c
15	VSS	159	DQ13	51	DM8_n/ DBI8_n.NC	195	VSS	87	ODT0	231	VDD	123	vss	267	DQS6_t
16	DQ8	160	VSS	52	NC	196	DQS8_c	88	VDD	232	A13	124	DQ54	268	vss
17	VSS	161	DQ9	53	VSS	197	DQS8_t	89	CS1_n	233	VDD	125	VSS	269	DQ55
18	DM1_n/ DBI1_n,NC	162	vss	54	CB6 DBI8_n,NC	198	VSS	90	VDD	234	NC	126	DQ50	270	vss
19	NC	163	DQS1_c	55	vss	199	CB7,NC	91	ODT1	235	NC	127	vss	271	DQ51
20	VSS	164	DQS1_t	56	CB2/NC	200	VSS	92	VDD	236	VDD	128	DQ60	272	vss
21	DQ14	165	VSS	57	vss	201	CB3,NC	93	NC	237	NC	129	vss	273	DQ61
22	vss	166	DQ15	58	RESET_n	202	vss	94	vss	238	SA2	130	DQ56	274	vss
23	DQ10	167	VSS	59	VDD	203	CKE1	95	DQ36	239	vss	131	vss	275	DQ57
24	VSS	168	DQ11	60	CKE0	204	VDD	96	VSS	240	DQ37	132	DM7_n/ DBI7_n,NC	276	vss
25	DQ20	169	VSS	61	VDD	205	NC	97	DQ32	241	vss	133	NC	277	DQS7_c
26	vss	170	DQ21	62	ACT_n	206	VDD	98	vss	242	DQ33	134	vss	278	DQS7_t
27	DQ16	171	VSS	63	BG0	207	BG1	99	DM4_n/ DBI4_n,NC	243	VSS	135	DQ62	279	VSS
28	VSS	172	DQ17	64	VDD	208	ALERT_n	100	NC	244	DQS4_c	136	VSS	280	DQ63
29	DM2_n/ DBI2_n,NC	173	VSS	65	A12/BC_n	209	VDD	101	VSS	245	DQS4_t	137	DQ58	281	VSS
30	NC	174	DQS2_c	66	A9	210	A11	102	DQ38	246	VSS	138	VSS	282	DQ59
31	VSS	175	DQS2_t	67	VDD	211	A7	103	VSS	247	DQ39	139	SA0	283	VSS
32	DQ22	176	VSS	68	A8	212	VDD	104	DQ34	248	VSS	140	SA1	284	VSSSPD
33	VSS	177	DQ23	69	A6	213	A5	105	VSS	249	DQ35	141	SCL	285	SDA
34	DQ18	178	VSS	70	VDD	214	A4	106	DQ44	250	VSS	142	VPP	286	VPP
35	VSS	179	DQ19	71	А3	215	VDD	107	VSS	251	DQ45	143	VPP	287	VPP
36	DQ28	180	VSS	72	A1	216	A2	108	DQ40	252	VSS	144	NC	288	VPP
Note:															



## 4. Architecture

### Pin Definition

Pin Name	Description	Pin Name	Description
A0-A17 <sup>1</sup>	SDRAM address bus	SCL	I <sup>2</sup> C serial bus clock for SPD/TSE
BAO, BA1	SDRAM bank select	SDA	I <sup>2</sup> C serial bus data line for SPD/TSE
BG0, BG1	SDRAM bank group select	SA0-SA2	I <sup>2</sup> C slave address select for SPD/TSE
RAS_n <sup>2</sup>	SDRAM row address strobe	PARITY	SDRAM parity input
CAS_n <sup>3</sup>	SDRAM column address strobe	VDD	SDRAM I/O & core power supply
WE_n <sup>4</sup>	SDRAM write enable	C0, C1,C2	Chip ID lines
CSO_n, CS1_n	DIMM Rank Select Lines	12 V	Optional power Supply on socket but not used on UDIMM
CKEO, CKE1	SDRAM clock enable lines	VREFCA	SDRAM command/address reference supply
ODT0, ODT1	SDRAM on-die termination control lines	VSS	Power supply return (ground)
ACT_n	SDRAM activate	VDDSPD	Serial SPD-TSE positive power supply
DQ0-DQ63	DIMM memory data bus	ALERT_n	SDRAM ALERT_n
CB0-CB7	DIMM ECC check bits (for x72 module)	VPP	SDRAM Supply
TDOC0 + TDOC0 +	Dummy loads for mixed populations of x4		
TDQS0_t-TDQS8_t	based and x8 based RDIMMs.		
TDQS0_c-TDQS8_c	Not used on UDIMMs.		
DOCO + DOCO +	SDRAM data strobes		
DQS0_t-DQS8_t	(positive line of differential pair)		
DQS0 c-DQS8 c	SDRAM data strobes	DECET »	Set DRAMs to a Known State
DQ30_t-DQ38_t	(negative line of differential pair)	KESEI_II	Set DRAIVIS to a Known State
DM0_n-DM8_n,	SDRAM data masks/data bus inversion	EV/ENT ~	SPD signals a thermal event has occurred.
DBIO_n-DBI8_n	(x8-based x72 DIMMs)	EAEINI TI	SPD Signals a thermal event has occurred.
CV0 + CV1 +	SDRAM clocks	VTT	SDRAM I/O termination supply
CKO_t, CK1_t	(positive line of differential pair)	VII	SUNAIVI I/O TEITIITIATION SUPPLY
CVO c CV1 c	SDRAM clocks	RFU	Reserved for future use
CK0_c, CK1_c	(negative line of differential pair)	KFU	neserveu ioi ruture use

Note 1 Address A17 is not valid for x8 and x16 based SDRAMs. For UDIMMs this connection pin is NC.

**Note 2** RAS\_n is a multiplexed function with A16.

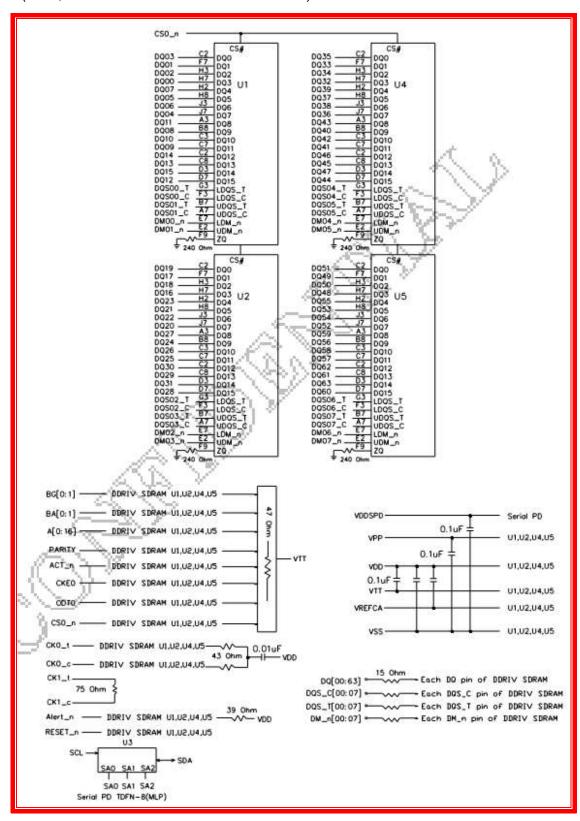
Note 3 CAS\_n is a multiplexed function with A15.

**Note 4** WE\_n is a multiplexed function with A14.



### Function Block Diagram:

- (2GB, 1 Rank 256Mx16 DDR4 SDRAMs)



Note: 1. The ZQ ball on each DDR4 component is connected to an external  $240\Omega \pm 1\%$  resistor that is tied to ground. It is used for the calibration of the component's ODT and output driver.

Rev 0.1



# 6. SDRAM Absolute Maximum Ratings

Symbol	Pa	arameter	Rating	Units	Note
_	On a setting Tanana set us	Normal Operating Temp.	0 to 85	°C	1,2
T <sub>OPER</sub>	Operation Temperature	Extended Temp.	85 to 95	°C	1,3
T <sub>STG</sub>	Storage Temperature		-55 to 100	°C	4,5
V <sub>IN,</sub> V <sub>OUT</sub>	Voltage on any pins rela	tive to Vss	-0.3 to +1.5	V	4
V <sub>DD</sub>	Voltage on VDD supply	relative to Vss	-0.3 to +1.5	V	4,6
V <sub>DDQ</sub>	Voltage on VDDQ suppl	y relative to Vss	-0.3 to +1.5	V	4,6

### Note

1. Operating Temperature TOPER is the case surface temperature on the center / top side of the DRAM.

For measurement conditions, please refer to the JEDEC document JESD51-2.

- 2. The Normal Temperature Range specifies the temperatures where all DRAM specifications will be supported. During operation, the DRAM case temperature must be maintained between 0 to 85 °C under all operating conditions.
- 3. Some applications require operation of the DRAM in the Extended Temperature Range between 85 °C and 95 °C case temperature. Full specifications are supported in this range, but the following additional conditions apply:
  - a) Refresh commands must be doubled in frequency, therefore reducing the Refresh interval tREFI to 3.9 μs. It is also possible to specify a component with 1X refresh (tREFI to 7.8μs) in the Extended Temperature Range. Please refer to supplier data sheet and/or the DIMM SPD for option availability.
- b) If Self-Refresh operation is required in the Extended Temperature Range, then it is mandatory to either use the Manual Self-Refresh mode with Extended Temperature Range capability (MR2 A6 =0b and MR2 A7 = 1b) or enable the optional Auto Self-Refresh mode (MR2 A6 = 1b and MR2 A7 =0b). Please refer to the supplier data sheet and/or the DIMM SPD for Auto Self-Refresh option availability, Extended Temperature Range support and tREFI requirements in the Extended Temperature Range.
- 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 5. Storage Temperature is the case surface temperature on the center/top side of the DRAM. For the measurement conditions, please refer to JESD51-2 standard.
- 6. VDD and VDDQ must be within 300 mV of each other at all times;and VREF must be not greater than 0.6 x VDDQ, When VDD and VDDQ are less than 500 mV; VREF may be equal to or less than 300 mV



# 7. Operating Condition

Symbol	Parameter	Min	Nom	Мах	Units	Notes
VDD	Supply Voltage	1.14	1.2	1.26	V	1
VPP	DRAM activating power supply	2.375	2.5	2.75	V	2
VREFCA(DC)	Input reference voltage command/ address bus	0.49 x VDD	0.5 x VDD	0.51 x VDD	V	3
Vтт	Termination Voltage	0.49 × VDD	0.5 × VDD	0.51 × VDD	V	4

### Note:

- VDDQ tracks with VDD; VDDQ and VDD are tied together.
- VPP must be greater than or equal to VDD at all times.
- 3. VREFCA must not be greater than 0.6 x VDD. When VDD is less than 500mV, VREF may be less than or equal to 300mV.
- 4. VTT termination voltages in excess of the specification limit adversely affect the voltage margins of command and address signals and reduce timing margins.



# 8. Operating, Standby, and Refresh Currents

- 2GB UDIMM (1 Rank 256Mx16 DDR4 SDRAMs)

Comple of	Dranged Conditions	Va	lue	l luite
Symbol	Proposed Conditions	IDD Max.	IPP Max.	Units
	Operating One Bank Active-Precharge Current (AL=0)CKE: High; External clock: On; tCK,			
	nRC, nRAS, CL: Refer to Component Datasheet for detail pattern; BL: 81; AL: 0; CS_n:			
	Highbetween ACT and PRE; Command, Address, Bank Group Address, Bank Address			
IDD0	Inputs: partially toggling; Data IO: VDDQ; DM_n:stable at 1; Bank Activity: Cycling with one	TBD	TBD	mA
	bank active at a time: 0,0,1,1,2,2,; Output Buffer and RTT: Enabled in Mode			
	Registers2;ODT Signal: stable at 0; Pattern Details: Refer to Component Datasheet for			
	detail pattern			
IDD0A	Operating One Bank Active-Precharge Current (AL=CL-1)	TBD	TBD	mA
IDDUA	AL = CL-1, Other conditions: see IDD0	טפו	טפו	MA
	Operating One Bank Active-Read-Precharge Current (AL=0)CKE: High;			
	External clock: On; tCK, nRC, nRAS, nRCD, CL: Refer to Component			
	Datasheet for detail pattern; BL: 81; AL: 0; CS_n: Highbetween ACT, RD and		TBD	
IDD4	PRE; Command, Address, Bank Group Address, Bank Address Inputs, Data	TDD		A
IDD1	IO: partially toggling; DM_n: stableat 1; Bank Activity: Cycling with one bank	TBD		mA
	active at a time: 0,0,1,1,2,2,; Output Buffer and RTT: Enabled in Mode			
	Registers2; ODT Signal: stable at 0; Pattern Details: Refer to Component			
	Datasheet for detail pattern			
IDDAA	Operating One Bank Active-Read-Precharge Current (AL=CL-1)	TDD	TDD	
IDD1A	AL = CL-1, Other conditions: see IDD1	TBD	TBD	mA
	Precharge Standby Current (AL=0)CKE: High; External clock: On; tCK, CL:			
	Refer to Component Datasheet for detail pattern; BL: 81; AL: 0; CS_n: stable at			
IDDON	1; Command,Address, Bank Group Address, Bank Address Inputs: partially	TDD	TDD	٥
IDD2N	toggling; Data IO: VDDQ; DM_n: stable at 1; Bank Activity: all banksclosed;	TBD	TBD	mΑ
	Output Buffer and RTT: Enabled in Mode Registers2; ODT Signal: stable at 0;			
	Pattern Details: Refer to Component Datasheet for detail pattern			
IDDS:	Precharge Standby Current (AL=CL-1)	TOO	TOO	
IDD2NA	AL = CL-1, Other conditions: see IDD2N	TBD	TBD	mA



	Precharge Standby ODT Current			
	CKE: High; External clock: On; tCK, CL: Refer to Component Datasheet for			
	detail pattern; BL: 81; AL: 0; CS_n: stable at 1; Command, Address, Bank			
IDD2NT	Group Address, Bank Address Inputs: partially toggling; Data IO: VSSQ;	TBD	TBD	mA
	DM_n: stable at 1; Bank Activity: all banks closed; Output Buffer and RTT:			
	Enabled in Mode Registers2; ODT Signal: toggling according; Pattern Details:			
	Refer to Component Datasheet for detail pattern			
IDD2NL	Precharge Standby Current with CAL enabled	TBD	TBD	mA
IDDZNL	Same definition like for IDD2N, CAL enabled3	טפו	טפו	IIIA
IDDANIO	Precharge Standby Current with Gear Down mode enabled	TDD	TDD	0
IDD2NG	Same definition like for IDD2N, Gear Down mode enabled3	TBD	TBD	mA
IDDALID	Precharge Standby Current with DLL disabled	TDD	TDD	4
IDD2ND	Same definition like for IDD2N, DLL disabled3	TBD	TBD	mA
IDDot	Precharge Standby Current with CA parity enabled	TDD	TDD	4
IDD2N_par	Same definition like for IDD2N, CA parity enabled3	TBD	TBD	mA
	Precharge Power-Down Current CKE: Low; External clock: On; tCK, CL: Refer			
	to Component Datasheet for detail pattern; BL: 81; AL:0; CS_n: stable at 1;		TBD	
IDESE	Command, Address, Bank Group Address, Bank Address Inputs: stable at 0;	TBD		A
IDD2P	Data IO: VDDQ; DM_n: stable at 1;			mA
	Bank Activity: all banks closed; Output Buffer and RTT: Enabled in Mode			
	Registers2; ODT Signal: stable at 0			
	Precharge Quiet Standby Current			
	CKE: High; External clock: On; tCK, CL: Refer to Component Datasheet for			
IDDAG	detail pattern; BL: 81; AL: 0; CS_n: stable at 1; Command,	<b>TD</b> 5	<b>TD</b> 5	
IDD2Q	Address, Bank Group Address, Bank Address Inputs: stable at 0; Data IO:	TBD	TBD	mA
	VDDQ; DM_n: stable at 1;Bank Activity: all banks closed;			
	Output Buffer and RTT: Enabled in Mode Registers2; ODT Signal: stable at 0			
	Active Standby Current			
	CKE: High; External clock: On; tCK, CL: Refer to Component Datasheet for			
	detail pattern; BL: 81; AL: 0; CS_n: stable at 1; Command,			
IDE:	Address, Bank Group Address, Bank Address Inputs: partially toggling; Data	<b>T</b> = -	<b>T</b> = -	
IDD3N	IO: VDDQ; DM_n: stable at 1;Bank Activity: all banks	TBD	TBD	mA
	open; Output Buffer and RTT: Enabled in Mode Registers2; ODT Signal: stable			
	at 0; Pattern Details:Refer to Component Datasheet			
	for detail pattern			



	Active Standby Current (AL=CL-1)			
IDD3NA	AL = CL-1, Other conditions: see IDD3N	TBD	TBD	mA
	Active Power-Down Current			
	CKE: Low; External clock: On; tCK, CL: sRefer to Component Datasheet for			
	detail pattern; BL: 81; AL: 0; CS_n: stable at 1; Command,			_
IDD3P	Address, Bank Group Address, Bank Address Inputs: stable at 0; Data IO:	TBD	TBD	mA
	VDDQ; DM_n: stable at 1; Bank Activity: all banks open;			
	Output Buffer and RTT: Enabled in Mode Registers2; ODT Signal: stable at 0			
	Operating Burst Read Current			
	CKE: High; External clock: On; tCK, CL: Refer to Component Datasheet for			
	detail pattern; BL: 82; AL: 0; CS_n: High between RD;			
	Command, Address, Bank Group Address, Bank Address Inputs: partially			
	toggling; Data IO: seamless read data burst with different			
IDD4R	data between one burst and the next one according; DM_n: stable at 1; Bank	TBD	TBD	mA
	Activity: all banks open, RD commands cycling through			
	banks: 0,0,1,1,2,2,; Output Buffer and RTT: Enabled in Mode Registers2;			
	ODT Signal: stable at 0; Pattern Details: Refer to			
	Component Datasheet for detail pattern			
IDD4RA	Operating Burst Read Current (AL=CL-1)	TDD	TDD	A
IDD4KA	AL = CL-1, Other conditions: see IDD4R	TBD	TBD	mA
IDD4RB	Operating Burst Read Current with Read DBI	TBD	TBD	mA
שואלים	Read DBI enabled3, Other conditions: see IDD4R	100	100	ША
	Operating Burst Write Current			
	CKE: High; External clock: On; tCK, CL: Refer to Component Datasheet for			
	detail pattern; BL: 81; AL: 0; CS_n: High between WR;			
	Command, Address, Bank Group Address, Bank Address Inputs: partially			
IDD4W	toggling ; Data IO: seamless write data burst with different	TBD	TBD	mA
100411	data between one burst and the next one; DM_n: stable at 1; Bank Activity: all	100	100	ША
	banks open, WR commands cycling through banks:			
	0,0,1,1,2,2,; Output Buffer and RTT: Enabled in Mode Registers2; ODT			
	Signal: stable at HIGH; Pattern Details: Refer to Component			
	Datasheet for detail pattern			
IDD4WA	Operating Burst Write Current (AL=CL-1)	TBD	TBD	mA
IDDAVVA	AL = CL-1, Other conditions: see IDD4W	100	100	IIIA
IDD4WB	Operating Burst Write Current with Write DBI	TBD	TBD	mA
1004440	Write DBI enabled3, Other conditions: see IDD4W	100	100	III/\



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IDD4WC	Operating Burst Write Current with Write CRC	TBD	TBD	mA
	Write CRC enabled3, Other conditions: see IDD4W			
IDD4W_par	Operating Burst Write Current with CA Parity	TBD	TBD	mA
	CA Parity enabled3, Other conditions: see IDD4W			
	Burst Refresh Current (1X REF)			
	CKE: High; External clock: On; tCK, CL, nRFC: Refer to Component Datasheet			
	for detail pattern; BL: 81; AL: 0; CS_n: High between			
IDD5B	REF; Command, Address, Bank Group Address, Bank Address Inputs: partially	TBD	TBD	mA
12202	toggling ; Data IO: VDDQ; DM_n: stable at 1; Bank	100	100	1117 (
	Activity: REF command every nRFC ; Output Buffer and RTT: Enabled in Mode			
	Registers2; ODT Signal: stable at 0; Pattern Details:			
	Refer to Component Datasheet for detail pattern			
	Burst Refresh Current (2X REF)			
IDD5F2	tRFC=tRFC_x2, Other conditions: see IDD5B	TBD	TBD	mA
IDD5F4	Burst Refresh Current (4X REF)	TBD	TBD	mA
155014	tRFC=tRFC_x4, Other conditions: see IDD5B	100	100	1117 (
	Self Refresh Current: Normal Temperature Range			
	TCASE: 0 - 85°C; Low Power Array Self Refresh (LP ASR) : Normal4; CKE:			
	Low; External clock: Off; CK_t and CK_c#: LOW; CL: Refer		TBD	
IDD6N	to Component Datasheet for detail pattern; BL: 81; AL: 0; CS_n#, Command,	TBD		mA
	Address, Bank Group Address, Bank Address, Data IO:			
	High; DM_n: stable at 1; Bank Activity: Self-Refresh operation; Output Buffer			
	and RTT: Enabled in Mode Registers2; ODT Signal: MIDLEVEL			
	Self-Refresh Current: Extended Temperature Range)			
	TCASE: 0 - 95°C; Low Power Array Self Refresh (LP ASR) : Extended4; CKE:			
	Low; External clock: Off; CK_t and CK_c: LOW; CL:			
IDDOE	Refer to Component Datasheet for detail pattern; BL: 81; AL: 0; CS_n,	TDD	TDD	A
IDD6E	Command, Address, Bank Group Address, Bank Address, Data	TBD	TBD	mA
	IO: High; DM_n:stable at 1; Bank Activity: Extended Temperature Self-Refresh			
	operation; Output Buffer and RTT: Enabled in Mode			
	Registers2; ODT Signal: MID-LEVEL			



	0.470 ( 1.0 ) 170 ( 1.0 )			
	Self-Refresh Current: Reduced Temperature Range			
	TCASE: 0 - TBD (~35-45)°C; Low Power Array Self Refresh (LP ASR) :			
	Reduced4; CKE: Low; External clock: Off; CK_t and CK_c#: LOW;			
IDD6R	CL: Refer to Component Datasheet for detail pattern; BL: 81; AL: 0; CS_n#,	TBD	TBD	mA
	Command, Address, Bank Group Address, Bank Address,			
	Data IO: High; DM_n:stable at 1; Bank Activity: Extended Temperature			
	Self-Refresh operation; Output Buffer and RTT: Enabled in Mode			
	Registers2; ODT Signal: MID-LEVEL			
	Auto Self-Refresh Current			
	TCASE: 0 - 95°C; Low Power Array Self Refresh (LP ASR) : Auto4;Partial Array		TBD	
	Self-Refresh (PASR): Full Array; CKE: Low; External			
IDDOA	clock: Off; CK_t and CK_c#: LOW; CL: Refer to Component Datasheet for	TDD		A
IDD6A	detail pattern; BL: 81; AL: 0; CS_n#, Command, Address, Bank	TBD		mA
	Group Address, Bank Address, Data IO: High; DM_n:stable at 1; Bank Activity:			
	Auto Self-Refresh operation; Output Buffer and RTT:			
	Enabled in Mode Registers2; ODT Signal: MID-LEVEL			
	Operating Bank Interleave Read Current			
	CKE: High; External clock: On; tCK, nRC, nRAS, nRCD, nRRD, nFAW, CL:			
	Refer to Component Datasheet for detail pattern; BL: 81; AL:			
	CL-1; CS_n: High between ACT and RDA; Command, Address, Bank Group			
1007	Address, Bank Address Inputs: partially toggling; DataIO: read data bursts with	TDD	TDD	A
IDD7	different data between one burst and the next one; DM_n: stable at 1; Bank	TBD	TBD	mA
	Activity: two times interleaved cycling			
	through banks (0, 1,7) with different addressing; Output Buffer and RTT:			
	Enabled in Mode Registers2; ODT Signal: stable at 0; Pattern			
	Details: Refer to Component Datasheet for detail pattern			
IDD8	Maximum Power Down Current TBD	TBD	TBD	mA



# 9. Timing Parameters

Clock Timing				
Parameter	Symbol	MIN	MAX	Units
Minimum Clock Cycle Time (DLL off mode)	tCK (DLL_OFF)	8	20	ns
Average Clock Period	tCK(avg)	0.750	<0.833	ns
Average high pulse width	tCH(avg)	0.48	0.52	tCK(avg)
Average low pulse width	tCL(avg)	0.48	0.52	tCK(avg)
Absolute Clock Period	tCK(abs)	tCK(avg)min  +  tJIT(per)min_  to t	tCK(avg)m ax + tJIT(per)m ax_tot	tCK(avg)
Absolute clock HIGH pulse width	tCH(abs)	0.45	-	tCK(avg)
Absolute clock LOW pulse width	tCL(abs)	0.45	-	tCK(avg)
Clock Period Jitter- total	JIT(per)_tot	-38	38	ps
Clock Period Jitter- deterministic	JIT(per)_dj	-19	19	ps
Clock Period Jitter during DLL lock-ing period	tJIT(per, lck)	-30	30	ps
Cycle to Cycle Period Jitter	tJIT(cc)_to-tal	7	5	ps
Cycle to Cycle Period Jitter during DLL locking period	tJIT(cc, lck)	6	0	ps
Duty Cycle Jitter	tJIT(duty)	TBD	TBD	ps
Cumulative error across 2 cycles	tERR(2per)	-55	55	ps
Cumulative error across 3 cycles	tERR(3per)	-66	66	ps
Cumulative error across 4 cycles	tERR(4per)	-73	73	ps
Cumulative error across 5 cycles	tERR(5per)	-78	78	ps
Cumulative error across 6 cycles	tERR(6per)	-83	83	ps



Cumulative error across 7 cycles	tERR(7per)	-87	87	ps
Cumulative error across 8 cycles	tERR(8per)	-91	91	ps
Cumulative error across 9 cycles	tERR(9per)	-94	94	ps
Cumulative error across 10 cycles	tERR(10per)	-96	96	ps
Cumulative error across 11 cycles	tERR(11per)	-99	99	ps
Cumulative error across 12 cycles	tERR(12per)	-101	101	ps
Cumulative error across 13 cycles	tERR(13per)	-103	103	ps
Cumulative error across 14 cycles	tERR(14per)	-104	104	ps
Cumulative error across 15 cycles	tERR(15per)	-106	106	ps
Cumulative error across 16 cycles	tERR(16per)	-108	108	ps
Cumulative error across 17 cycles	tERR(17per)	-110	110	ps
Cumulative error across 18 cycles	tERR(18per)	-112	112	ps
Cumulative error across n = 13, 14 49, 50 cycles	tERR(nper)	tERR(nper)max	((1 + 0.68ln(n)) * total min) = ((1 + 0.68ln(n)) _total max)	ps
Command and Address setup time to CK_t, CK_c referenced to Vih(ac) / Vil(ac) levels	tIS(base)	TBD	-	ps
Command and Address setup time to CK_t, CK_c referenced to Vref levels	tlS(Vref)	TBD	-	ps
Command and Address hold time to CK_t, CK_c referenced to Vih(dc) / Vil(dc) levels	tIH(base)	TBD	-	ps



Command and Address hold time to CK_1, CK_c referenced to Vref levels  Control and Address Input pulse width for each input  Command and Address Timing  Parameter Symbol MilN MAX Units  CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay for different bank group  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  Four activate window for 1/KB page size  Four activ	-				
to Viref levels  Control and Address Input pulse width for each input  Command and Address Timing  Parameter Symbol Miln MAX Units  CAS_n to CAS_n command delay for same bank group  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page  size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page  size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB  page size  Four activate window for 1KB	Command and Address hold				
Control and Address Input pulse width for each input  Command and Address Timing  Parameter Symbol MIN MAX Units  CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay to different bank group  ACTIVATE to ACTIVATE  Command delay to different bank group ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group for 1/2 XB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  Four activate window for 1 KB page size	time to CK_t, CK_c referenced	tIH(Vref)	TBD	-	ps
tIPW 385 - ps  pulse width for each input  Command and Address Timing  Parameter Symbol MIN MAX Units  CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay to different bank group  ACTIVATE to ACTIVATE  Command delay to different bank group to T2KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group to T2KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group to T2KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE  Command delay to same bank group for 1/2 KB page size  Four activate window for 1 KB page size  Four activate window for 1 KB page size  Four activate window for 1 KFAW_1/2 K  Max(16nCK,1 1 ns)  IFAW_1/2 K  Max(16nCK,1 1 ns)  Axis Max(16nCK,1 1 ns)	to Vref levels				
Command and Address Timing  Parameter Symbol MIN MAX Units  CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay for different bank group  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 ZB page size  Four activate window for 1 ZB page size  Four activate window f	Control and Address Input	+1D\A/	205		nc
Parameter Symbol MIN MAX Units  CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay for different bank group  ACTIVATE to ACTIVATE Command delay to different tarRD_S(2K)  Bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different tarRD_S(1K)  Max(4nCK,5. 3ns)  ACTIVATE to ACTIVATE Command delay to different tarRD_S(1K)  Max(4nCK,3ns)  ACTIVATE to ACTIVATE Command delay to different tarRD_S(1K)  Max(4nCK,3ns)  ACTIVATE to ACTIVATE Command delay to different tarRD_S(1/2K)  Max(4nCK,3ns)  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  Four activate window for 2 KB page size  Four activate window for 1 KFAW_1/2 K  Max(16nCK,1 2ns)  Axx(16nCK,1 2ns)  Axx(16nCK,1 2ns)  Axx(16nCK,1 2ns)  Axx(16nCK,1 2ns)	pulse width for each input	tir VV	363	-	μs
CAS_n to CAS_n command delay for same bank group  CAS_n to CAS_n command delay for different bank group  ACTIVATE to ACTIVATE Command delay to different bank group  ACTIVATE to ACTIVATE Command delay to different bank group in the page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 kB page size  Four activate window for 2 kB page size  Four activate window for 1 kB page size  Four activa	Command and Address Timing				
delay for same bank group  CAS_n to CAS_n command delay for different bank group  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window for 1KB page size  Four activate window for 1/2KB page size  Four activate window for 1/2KB page size  Four activate window for 1/2KB page size  Total cancer  ACTIVATE to ACTIVATE AMAX(4nCK,4. 9ns)  AMAX(4nCK,5. AMAX(4nCK,5. ANCK AMAX(4nCK,6. ANCK AMAX(4nCK,6. ANCK AMAX(4nCK,6. A	Parameter	Symbol	MIN	MAX	Units
CAS_n to CAS_n command   CCCD_S	CAS_n to CAS_n command	1000 1	max(5 nCK,		O.
delay for different bank group  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/4 B page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/4 B page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/4 B page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/4 B page size  Four activate window for 2 KB page size  Four activate window for 1	delay for same bank group	tCCD_L	5 ns)	-	nCK
ACTIVATE to ACTIVATE Command delay to different transported transp	CAS_n to CAS_n command		_		211
Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window fo	delay for different bank group	tCCD_S	4	-	nCK
Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window	ACTIVATE to ACTIVATE				
bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window for 1 KB page size  Four activate window for 1/2KB page size  TEAW_1/2K  Max(4nCK,4. 9ns)  Amax(4nCK,4. 9ns)  Amax(4nCK,6. Ans)  Amax(4nCK,6	Command delay to different	tRRD_S(2K)		-	nCK
Command delay to different bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/4 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/4 KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2 KB page size  Four activate window for 2 KB page size  Four activate window for 1 KB page size  Four activate window	bank group for 2KB page size		3ns)		
bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to different bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1ZKB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window for 1KB page size  Four activate window for 1/2KB page size  TFAW_1/2K  Max(16nCK,1 2ns)  Max(16nCK,1 2ns)	ACTIVATE to ACTIVATE				
ACTIVATE to ACTIVATE Command delay to different bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size	Command delay to different	tRRD_S(1K)	Max(4nCK,3ns)	-	nCK
Command delay to different bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate windo	bank group for 2KB page size				
bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window for 1/2KB page size  Four activate window for 1/2KB page size  Four activate window for 1/2KB page size  TFAW_1K  Max(4nCK,4. 9ns)  Max(4nCK,4. 9ns)  Amax(4nCK,4. 9ns)  Max(4nCK,4. 9ns)  The Max(4nCK,4. 9ns)  Amax(4nCK,4. 9ns)  The Max(4nCK,4. 9ns	ACTIVATE to ACTIVATE				
bank group for 1/ 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window for 1KB page size  Four activate window for 1KB page size  Four activate window for 1/2KB page size  TFAW_1K  Max(2onCK,2 1ns)  Max(16nCK,1 2ns)	Command delay to different				
ACTIVATE to ACTIVATE Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Team activate window for 1KB page size	bank group for 1/ 2KB page	tRRD_S(1/ 2K)	Max(4nCK,3ns)	-	nCK
Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  TEAW_1/2K Page size  Max(4nCK,4.  - nCK  Max(4nCK,4.	size				
Command delay to same bank group for 2KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size	ACTIVATE to ACTIVATE				
ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  TEAW_1/2K Page size  Max(4nCK,4.  9ns)  Max(2nCK,4.  9ns)  Max(28nCK,3.  0ns)  Max(20nCK,2.  1ns)  Four activate window for 1KB page size  TEAW_1/2K  Nax(16nCK,1.  2ns)	Command delay to same bank	tRRD_L(2K)		-	nCK
Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  The W_1/2K Page size  Max(4nCK,4.  9ns)  Max(4nCK,4.  9ns)  Max(28nCK,3  0ns)  Max(20nCK,2  1ns)  Four activate window for 1KB page size  Max(20nCK,2  1ns)  Four activate window for 1KB page size	group for 2KB page size		4ns)		
Command delay to same bank group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  TFAW_1/2KB page size  TRRD_L(1/2K) Page size  Max(4nCK,4. Page size  Max(28nCK,3 Page size  Max(20nCK,2 Page size  Max(16nCK,1 P	ACTIVATE to ACTIVATE				
group for 1KB page size  ACTIVATE to ACTIVATE Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  Four activate window for 1KB page size  Four activate window for 1KB page size  Four activate window for 1/2KB page size  TFAW_1K  Max(28nCK,3 Ons)  Max(28nCK,3 Ons)  Max(20nCK,2 Ins)  Max(20nCK,2 Ins)  Max(16nCK,1 Ins)	Command delay to same bank	tRRD_L(1K)		-	nCK
Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  TFAW_1K  Max(29nCK,2 1ns)  Max(20nCK,2 2ns)  Ins	group for 1KB page size		9ns)		
Command delay to same bank group for 1/2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  TFAW_1/2K	ACTIVATE to ACTIVATE				
Four activate window for 2KB page size  Four activate window for 2KB page size  Four activate window for 1KB page size  This page size  This page size  Max(28nCK,3 page size pa	Command delay to same bank	tRRD_L(1/ 2K)		-	nCK
page size  tFAW_2K  Ons)  Four activate window for 1KB page size  tFAW_1K  Ins)  Four activate window for 1/2KB page size  tFAW_1/2K  Max(16nCK,1 2ns)  ns  ns	group for 1/2KB page size		9ns)		
page size Ons)  Four activate window for 1KB page size  Tour activate window for 1KB page size	Four activate window for 2KB		Max(28nCK,3		
page size  tFAW_1K  1ns)  Four activate window for 1/2KB page size  tFAW_1/2K  2ns)  tFAW_1S  To ns  ns  ns	page size	tFAW_2K	Ons)	-	ns
page size 1ns)  Four activate window for tFAW_1/2K	Four activate window for 1KB		Max(20nCK,2		
tFAW_1/2K - ns 1/2KB page size 2ns)	page size	tFAW_1K	1ns)	-	ns
1/2KB page size 2ns)	Four activate window for		Max(16nCK,1		
Delay from start of internal tWTR_S max(2nCK,2	1/2KB page size	tFAW_1/2K	2ns)	-	ns
m the state of the	Delay from start of internal	tWTR_S	max(2nCK,2.	-	



T				
write transaction to internal		5ns)		
read com-mand for different				
bank group				
Delay from start of internal				
write transaction to internal		max(4nCK,7.		
read com-mand for same	tWTR_L	5ns)	-	
bank group				
Internal READ Command to		max(4nCK,7.		
PRE-CHARGE Command delay	tRTP	5ns)	-	
WRITE recovery time	tWR	15	-	ns
		tWR+max		
Write recovery time when	tWR_CRC _DM	(5nCK,3.75ns	-	ns
CRC and DM are enabled		)		
delay from start of internal				
write transaction to internal		tWTR_S+ma		
read com-mand for different	tWTR_S_C RC_DM	х	-	ns
bank group with both CRC and		(5nCK,3.75ns		
DM enabled		)		
delay from start of internal				
write transaction to internal		tWTR L+max		
read com-mand for same	tWTR_L_C RC_DM	(5nCK,3.75ns	-	ns
bank group with both CRC and		)		
DM enabled				
DLL locking time	tDLLK	854	-	nCK
Mode Register Set command				
cycle time	tMRD	8	-	nCK
Mode Register Set command		max(24nCK,1		
up-date delay	tMOD	5ns)	-	
Multi-Purpose Register		_		011
Recovery Time	tMPRR	1	-	nCK
Multi Purpose Register Write	1110 1100	tMOD (min)		
Re-covery Time	tWR_MPR	+ AL + PL	-	-
Auto precharge write recovery	1D11/ 1.	Programmed WF	R + roundup ( tRP	017
+ precharge time	tDAL(min)	/ tCK	(avg))	nCK
DQ0 or DQL0 driven to 0				
set-up time to first DQS rising	tPDA_S	0.5	-	UI
edge				



				1
DQ0 or DQL0 driven to 0 hold time from last DQS fall-ing	tPDA_H	0.5	-	UI
edge				
CS_n to Command Address Late	ncy			
CS_n to Command Address	tCAL	F		nCK
Laten-cy	ICAL	5	-	TICK
DRAM Data Timing				
DQS_t,DQS_c to DQ skew, per				tCK(avg)
group, per access	tDQSQ	-	0.18	/2
DQ output hold time from	tQH	0.74		tCK(avg)
DQS_t,DQS_c	tQH	0.74	-	/2
Data Valid Window per				
device: tQH - tDQSQ for a	tDVWd	TBD	-	UI
device				
Data Valid Window per				
device, per pin: tQH - tDQSQ	tDVWp	0.72	-	UI
each device's out-put	ιοννγρ	0.72		Ç.
DQ low impedance time from				
	tLZ(DQ)	-310	170	Ps
CK_t, CK_c				
DQ high impedance time from	tHZ(DQ)	-	170	ps
CK_t, CK_c				
Data Strobe Timing				
DQS_t, DQS_c differential	tRPRE	0.9	-	tCK
READ Preamble				
DQS_t, DQS_c differential	tRPST	0.33	-	tCK
READ Postamble		0.55		ton
DQS_t,DQS_c differential	tQSH	0.4	_	tCK
output high time	iQ3FI	0.4		ick
DQS_t,DQS_c differential	100	0.4		101/
output low time	tQSL	0.4	-	tCK
DQS_t, DQS_c differential				
WRITE Preamble	tWPRE	0.9	-	tCK
DQS_t, DQS_c differential				
WRITE Postamble	tWPST	0.33	-	tCK
DQS_t and DQS_c				
low-impedance time	tLZ(DQS)	-310	170	ps
(Referenced from RL-1)				·



DQS_t and DQS_c high-impedance time (Referenced from RL+BL/2)	tHZ(DQS)	-	170	ps	
DQS_t, DQS_c differential input low pulse width	tDQSL	0.46	0.54	tCK	
DQS_t, DQS_c differential input high pulse width	tDQSH	0.46	0.54	tCK	
DQS_t, DQS_c rising edge to  CK_t, CK_c rising edge (1 clock  preamble)	tDQSS	-0.27	0.27	tCK	
DQS_t, DQS_c falling edge setup time to CK_t, CK_c rising edge	tDSS	0.18	-	tCK	
DQS_t, DQS_c falling edge hold time from CK_t, CK_c rising edge	tDSH	0.18	-	tCK	
DQS_t, DQS_c rising edge output timing locatino from rising	tDQSCK (DLL On)	-170	170	ps	
DQS_t, DQS_c rising edge output variance window per DRAM	tDQSCKI (DLL On)		270	ps	
MPSM Timing					
Command path disable delay upon MPSM entry	tMPED	tMOD(min) + tCPDED(min)	-		
Valid clock requirement after MPSM entry	tCKMPE	tMOD(min) + tCPDED(min)	-		
Valid clock requirement before MPSM exit	tCKMPX	tCKSRX(min)			
Exit MPSM to commands not requiring a locked DLL	tXMP	txs(imin)			
Exit MPSM to commands requiring a locked DLL	tXMPDLL	tXMP(min) + tXSDLL(min)			
CS setup time to CKE	tMPX_S	tISmin + tIHmin	-		
Calibration Timing	Calibration Timing				
Power-up and RESET	tZQinit	1024	-	nCK	



calibration time				
Normal operation Full	tZQoper	512	-	nCK
calibration time	3- p	-		-
Normal operation Short	tZQCS	128	_	nCK
calibration time	izqes	120		HER
Reset/Self Refresh Timing				
		max		
Exit Reset from CKE HIGH to a	Luxaa	(5nCK,tRFC(		
valid command	command tXPR	min)+	-	
		10ns)		
Exit Self Refresh to commands		tRFC(min)+1		
not requiring a locked DLL	tXS	0ns	-	
SRX to commands not				
requiring a locked DLL in Self	tX-S_ABORT( min)	tRFC4(min)+	-	
Refresh ABORT	_ ,	10ns		
Exit Self Refresh to ZQCL,ZQCS				
and MRS (CL,CWL,WR,RTP and	tXS_FAST (min)	tRFC4(min)+	-	
Gear Down)	0.0_17.01 (11111)	10ns		
Exit Self Refresh to commands				
re-quiring a locked DLL	tXSDLL	tDLLK(min)	-	
Minimum CKE low width for				
Self re-fresh entry to exit	tCKESR	tCKE(min)+1	_	
timing	teresit	nCK		
Minimum CKE low width for				
Self re-fresh entry to exit	+CVECD DAD	tCKE(min)+		
·	tCKESR_ PAR	1nCK+PL	-	
timing with CA Parity enabled				
Valid Clock Requirement after	+C//CDE	max(5nCK,10		
Self Refresh Entry (SRE) or	tCKSRE	ns)	-	
Power- Down Entry (PDE)				
Valid Clock Requirement after		max		
Self Refresh Entry (SRE) or	tCKS-RE_PAR	(5nCK,10ns)	-	
Power- Down when CA Parity		+PL		
is enabled				
Valid Clock Requirement				
before Self Refresh Exit (SRX)	tCKSRX	max(5nCK,10	-	
or Power-Down Exit (PDX) or	CROIN	ns)		
Reset Exit				



Power Down Timing				
Exit Power Down with DLL on				
to any valid command;Exit				
Precharge Power Down with	tXP	(4nCK,6ns)	-	
DLL frozen to commands not				
requiring a locked DLL				
CKE minimum pulse width	tCKE	max (3nCK,		
CKE minimum puise width	tCKL	5ns)	-	
Command pass disable delay	tCPDED	4	-	nCK
Power Down Entry to Exit			-4	
Timing	tPD	tCKE(min)	9*tREFI	
Timing of ACT command to				
Power Down entry	tACTPDEN	2	-	nCK
Timing of PRE or PREA				
command to Power Down	tPRPDEN	2	-	nCK
entry	•····· = =··	_		
Timing of RD/RDA command				
to Power Down entry	tRDPDEN	RL+4+1	-	nCK
Timing of WR command to	#WDDDEN	WL+4+(tWR/	-	CIV
Power Down entry (BL8OTF,	tWRPDEN	tCK(avg))		nCK
BL8MRS, BC4OTF)				
Timing of WRA command to				
Power Down entry (BL8OTF,	tWRAPDEN	WL+4+WR+1	-	nCK
BL8MRS, BC4OTF)				
Timing of WR command to	tWRP-BC4DEN	WL+2+(tWR/	-	nCK
Power Down entry (BC4MRS)		tCK(avg))		
Timing of WRA command to	tWRAP-BC4DEN	WL+2+WR+1	_	nCK
Power Down entry (BC4MRS)	CANIVAL-DCADFIA	**	-	HCK
Timing of REF command to	+DEEDDEN	2		~CV
Power Down entry	tREFPDEN	2	-	nCK
Timing of MRS command to				
Power Down entry	tMRSPDEN	tMOD(min)	-	
PDA Timing				
Mode Register Set command		max(16nCK,1		
cycle time in PDA mode	tMRD_PDA	Ons)		
Mode Register Set command			<u> </u>	
up-date delay in PDA mode	tMOD_PDA	tMOD		
ap date delay iii i b/(iiiode				



ODT Timing				
Asynchronous RTT turn-on				
delay (Power-Down with DLL	tAONAS	1.0	9.0	ns
frozen)				
Asynchronous RTT turn-off				
delay (Power-Down with DLL	taofas	1.0	9.0	ns
frozen)				
RTT dynamic change skew	tADC	0.3	0.7	tCK(avg)
Write Leveling Timing				
First DQS_t/DQS_n rising edge				
af-ter write leveling mode is	tWLMRD	40	-	nCK
pro-grammed				
DQS_t/DQS_n delay after				
write lev-eling mode is	tWLDQSEN	25	-	nCK
programmed				
Write leveling setup time				
from rising CK_t, CK_c	tWLS	0.13	_	tCK(avg)
crossing to rising	(WLS	0.13		(* 6)
DQS_t/DQS_n crossing				
Write leveling hold time from				
rising DQS_t/DQS_n crossing	tWLH	0.13	-	tCK(avg)
to rising CK_t, CK_ crossing				
Write leveling output delay	tWLO	0	9.5	ns
Write leveling output error	tWLOE		2	ns
CA Parity Timing				
Commands not guaranteed to	tPAR_UN-KNOWN	_	PL	
be executed during this time	tran_on-known	-	r L	
Delay from errant command	tPAR_ALER T_ON	_	PL+6ns	
to ALERT_n assertion	LIAN_ALLIVI_ON	-	1 1 10113	
Pulse width of ALERT_n signal	tPAR_ALER T_PW	80	160	nCK
when asserted	TRAIN_ALLIN 1_FW	60	100	IICK
Time from when Alert is				
asserted till controller must				
start providing DES	tPAR_ALER T_RSP	-	71	nCK
commands in Persistent CA				
parity mode				
Parity Latency	PL	į	5	nCK

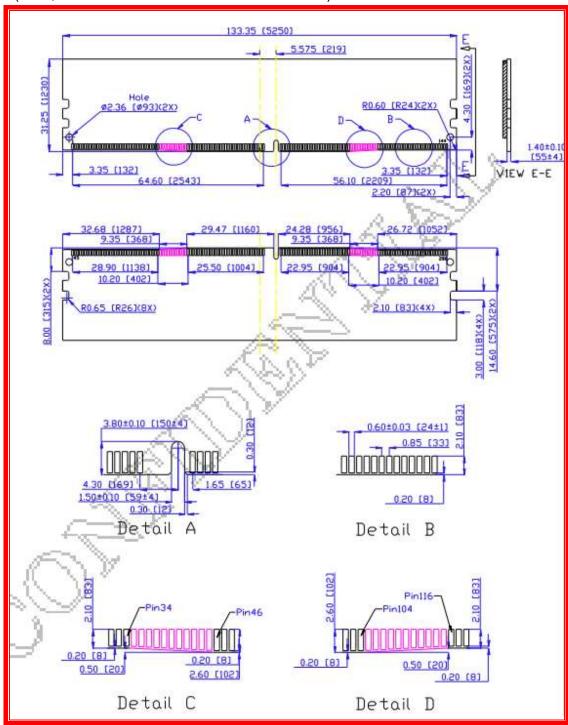


CRC Error Reporting				
CRC error to ALERT_n latency	tCRC_ALER T	3	13	ns
CRC ALERT_n pulse width	CRC_ALER T_PW	6	10	nCK
tREFI				
	2Gb	160	-	ns
+DFC1 /min)	4Gb	260	-	ns
tRFC1 (min)	8Gb	350	-	ns
	16Gb	550	-	ns
	2Gb	110	-	ns
+DFC2 /min)	4Gb	160	-	ns
tRFC2 (min)	8Gb	260	-	ns
	16Gb	350	-	ns
	2Gb	90	-	ns
tRFC3 (min)	4Gb	110	-	ns
	8Gb	160	-	ns
	16Gb	260	-	ns



### 10. PACKAGE DIMENSION

- (2GB, 1 Rank 256Mx16 DDR4 base UDIMM)



Note: All dimensions are in millimeters (mils) and should be kept within a tolerance of  $\pm 0.15$  (6), unless otherwise specified.



### 11. RoHS Declaration

innodisk

# 宜鼎國際股份有限公司

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# Innodisk Corporation

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# ROHS 自我宣告書(RoHS Declaration of Conformity)

### Manufacturer Product: All Innodisk EM Flash and Dram products

一、宣鼎國際股份有限公司(以下稱本公司)特此保證售予責公司之所有產品,皆符合歐盟 2011/65/EU及(EU) 2015/863 關於 RoHS 之規範要求。

Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.

二、本公司同意因本保證書或與本保證書相關事宜有所爭議時,雙方宜友好協商,達成協議。 Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鍋 (Cd)	< 100 ppm
六價絡 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBs)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm
鄰苯二甲酸二(2-乙 基己 基)酯 (DEHP)	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯 (BBP)	< 1000 ppm
鄭某二甲酸二丁酯 (DBP)	< 1000 ppm
鄰苯二甲酸二異丁酯 (DIBP)	< 1000 ppm

### 立 保 證 書 人 (Guarantor)

Company name 公司名稱: Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人: Randy Chien 簡川勝

Company Representative Title 公司代表人職稱: Chairman 董事長

Date 日 期: 2017 / 01 / 18







# **Revision Log**

Rev	Date	Modification
0.1	15 <sup>th</sup> Jan 2019	Preliminary Edition